

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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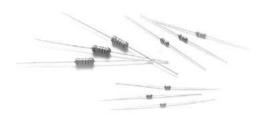






# General Type

Normal & Miniature Style [MFR Series]



# INTRODUCTION

The MFR Series Metal Film Resistors are manufactured using a vacuum sputtering system to deposit multiple layers of mixed metal alloys and passivative materials onto a carefully treated high grade ceramic substrate. After a helical groove has been cut in the resistive layer, tinned connecting leads of electrolytic copper are welded to the end-caps. The resistors are coated with layers of blue color lacquer.

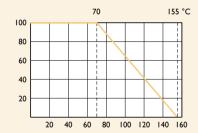
#### **FEATURES**

Power Rating	1/6W, 1/4W, 1/2W, 1W, 2W, 3W
Resistance Tolerance	±0.5%, ±1%, ±5%
T.C.R.	±15ppm/°C, ±25ppm/°C, ±50ppm/°C, ±100ppm/°C

### **DERATING CURVE**

For resistors operated in ambient temperatures above 70°C, power rating must be derated in accordance with the curve below.

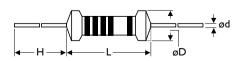
Rated Load (%)



Ambient Temperature (°C)

#### **DIMENSIONS**

Unit: mm



STYLE		DIMENSIO	ON		
Normal	Miniature	L	øD	н	ød
MFR-12	MFR25S	3.4±0.3	1.9±0.2	28±2.0	0.45±0.05
MFR-25	MFR50S	6.3±0.5	2.4±0.2	28±2.0	0.55±0.05
MFR-50	MFRIWS	9.0±0.5	3.3±0.3	26±2.0	0.55±0.05
MFR100	MFR2WS	11.5±1.0	4.5±0.5	35±2.0	0.8±0.05
MFR200	MFR3WS	15.5±1.0	5.0±0.5	33±2.0	0.8±0.05

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Note:		 	

## **ELECTRICAL CHARACTERISTICS**

STYLE	MFR-12	MFR25S	MFR-25	MFR50S	MFR-50	MFRIWS	MFRI00	MFR2WS MFR200	MFR3WS
Power Rating at 70°C	1/6W	1/4W		1/2W		IW		2W	3W
Maximum Working Voltage	200V		250V	300V	350V	400V	500V	_	
Maximum Overload Voltage	400V		500V	600V	700V	800V	1,000V		
Voltage Proof on Insulation	300V	400V	500V			700V	1,000V		
Resistance Range	ΙΩ - ΙΟΜΩ	$I\Omega$ - $I$ 0M $\Omega$ & $0\Omega$ for E24 & E96 series value							
Operating Temp. Range	-55°C to +	-55°C to +155°C							
Temperature Coefficient	±15ppm/°C, ±25ppm/°C, ±100ppm/°C								

Note: Special value is available on request

## **ENVIRONMENTAL CHARACTERISTICS**

PERFORMANCE TEST	TEST METHOD		APPRAISE	
Short Time Overload IEC 60115-1 4.13 2.5 tim		2.5 times RCWV for 5 Sec.	±0.25%+0.05Ω	
Voltage Proof on Insulation	IEC 60115-1 4.7	in V-block for 60 Sec., test voltage by type	By type	
Temperature Coefficient	IEC 60115-1 4.8	-55°C to +155°C	By type	
Insulation Resistance	IEC 60115-1 4.6	in V-block for 60 Sec.	>10,000ΜΩ	
Solderability	IEC 60115-1 4.17	235±5°C for 3±0.5 Sec.	95% Min. coverage	
Solvent Resistance of Marking	IEC 60115-1 4.30	IPA for 5±0.5 Min, with ultrasonic	No deterioration of coatings and markings	
Robustness of Terminations	IEC 60115-1 4.16	Direct load for 10 Sec. in the direction of the terminal leads	≥2.5kg (24.5N)	
Periodic-pulse Overload	IEC 60115-1 4.39	4 times RCWV 10,000 cycles (1 Sec. on, 25 Sec. off)	±1.0%+0.05Ω	
Damp Heat Steady State	IEC 60115-1 4.24	40±2°C, 90-95% RH for 56 days, loaded with 0.1 times RCWV	±1.5%+0.05Ω	
Endurance at 70°C	IEC 60115-1 4.25	70±2°C at RCWV for 1,000 Hr. (1.5 Hr. on, 0.5 Hr. off)	±1.5%+0.05Ω	
Temperature Cycling	IEC 60115-1 4.19	-55°C ⇒ Room Temp. ⇒ +155°C ⇒ Room Temp. (5 cycles)	±0.75%+0.05Ω	
Resistance to Soldering Heat	IEC 60115-1 4.18	260±3°C for 10±1 Sec., immersed to a point 3±0.5mm from the body	±0.25%+0.05Ω	

#### **EXPLANATIONS OF ORDERING CODE**

Code I - 3

Code 7

**Tolerance** 

 $P = \pm 0.02 \%$ 

 $A = \pm 0.05 \%$ 

B = +0.1%

C = +0.25%

 $D = \pm 0.5 \%$ 

F = ±1 %

 $G = \pm 2 \%$ 

 $| = \pm 5 \%$ 

 $K = \pm 10 \%$ 

- = Base on Spec

**52-**

 $\overline{100}R$ 

Code 13 - 17

0RI = 0.1

100R = 100

10K = 10.000

10M = 10,000,000

Resistance Value

**Series Name** See Index

Code 4 - 6

**Power Rating** -05 = ød0.5mm

> -06 = ød0.6mm-07 = ød0.7mm

> -08 = ød0.8mm-10 = ød1.0mm

> -14 = ød1.4mm

-12 = 1/6W

-25 = 1/4W

25S = 1/4WS

-50 = 1/2W

50S = 1/2WS100 = 1 W

IWS = IWS

200 = 2W

2WS = 2WS

204 = 0.4W

207 = 0.6W

500 = 5W

5WS = 5WS

5SS = 5WSS

7WS = 7WS

20A = 20W

30A = 30W

40A = 40W

50A = 50W

25A = 25W

25B = 250W

Code 8

**Packing Style** 

T = Tape/BoxR = Tape/Reel

B = Bulk

Code 9

Temperature Coefficient of Resistance

- = Base on Spec.

 $A = \pm 5 \text{ ppm/}^{\circ}\text{C}$ 

 $B = \pm 10 \text{ ppm/}^{\circ}\text{C}$ 

 $C = \pm 15 \text{ ppm/}^{\circ}C$ 

 $S = \pm 20ppm/^{\circ}C$ 

 $D = \pm 25 \text{ ppm/}^{\circ}C$ 

 $E = \pm 50 \text{ ppm/}^{\circ}\text{C}$ 

 $F = \pm 100 \text{ ppm/°C}$ 

 $G = \pm 200 \text{ ppm/}^{\circ}C$ 

 $H = \pm 250 \text{ ppm/°C}$  $I = \pm 300 \text{ ppm/°C}$ 

 $I = \pm 350 \text{ ppm/°C}$ 

Code 10 - 12

Forming Type

26 - 26mm52- = 52.4mm

73 - = 73 mm

81 - 81 mm

91 - = 91 mm

F = FType

FK = FKType

FKK = FKK Type

FFK = F-form Kink

M = M-Type Forming

MB = M-form W/flat

MT = MT Type Forming

MR = MRType

AV = AVIsert

PN = PANAsert

300 = 3W3WS = 3WS

3WM = 3WM

400 = 4W

700 = 7W

10A = 10W

10S = 10WS

15A = 15W

10B = 100W

**EXCEPTION:** 

• Cement series:

<Code 8>: Special packing style code

B: Bulk with wirewound or metal oxide sub-assembly for resistance value

W: Bulk with ceramic based wirewound sub-assembly for resistance value

M: Bulk with metal oxide sub-assembly for resistance value

F: Bulk with Fiberglass based wirewound sub-assembly for resistance value

<Code 10-12>: Without forming code

Example: SQP500|B-I0R

#### • JPW series:

<Code 13-17>: without resistance value code

Example: **JPW-06-T-52-**